



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

Product Summary

BV _{DSS}	Rds(on)	Ι _D T _C = +25°C
60V	16mΩ @ V _{GS} = 10V	37.1A
00 V	24mΩ @ V _{GS} = 4.5V	30.3A

Description

This MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management
- DC-DC Converters
- Motor Control

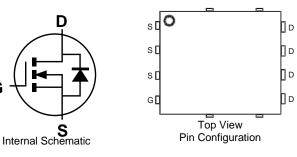
Features

- Rated to +175° C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Thermally Efficient Package Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH6016LPSQ</u>)

Mechanical Data

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (@3)
- Weight: 0.097 grams (Approximate)





Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6016LPS-13	PowerDI5060-8	2,500 / Tape & Reel

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Notes:	1. EU Directive 2002/95/EC (R	oHS) & 2011/65/EU (RoHS	2) compliant. All applicable R	OHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



☐ I I=Manufacturer's Marking
 H6016LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 16 = 2016)
 WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	T _C = +25°C T _C = +100°C	ID	37.1 26.2	A
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	I _D	10.6 7.5	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	75	А
Maximum Continuous Body Diode Forward Current (Note 6)		Is	31	А
Avalanche Current, L = 0.1mH		I _{AS}	15.3	А
Avalanche Energy, L = 0.1mH		Eas	11.7	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3	W
Thermal Resistance, Junction to Ambient (Note 5)		R _{θJA}	49	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	37.5	W
Thermal Resistance, Junction to Case (Note 6)		R _{θJC}	4	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

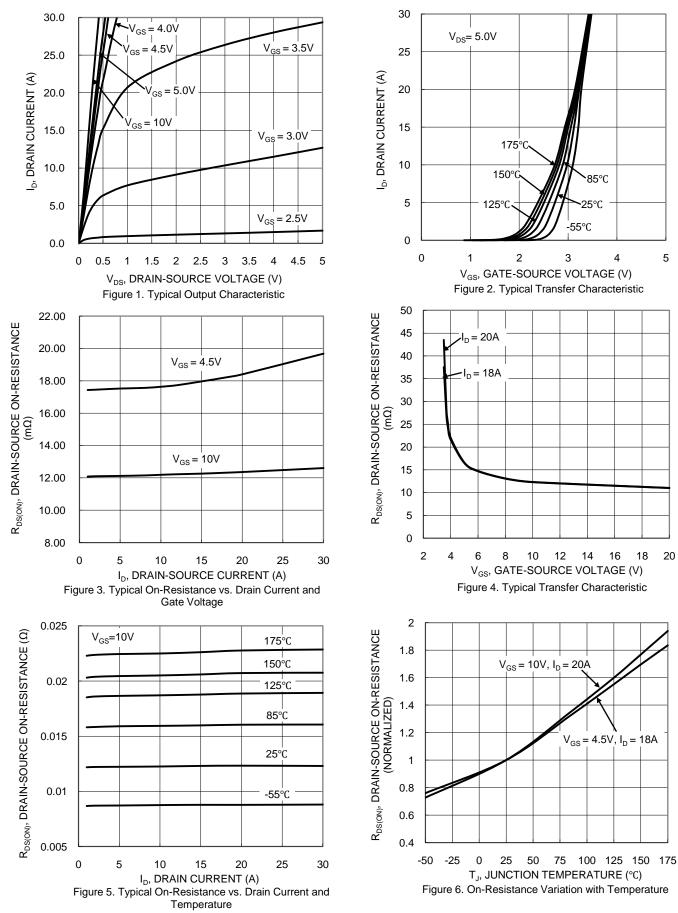
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	-	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)				•			
Gate Threshold Voltage	V _{GS(TH)}	1	—	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	р		—	16		$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	—	24	mΩ	V _{GS} = 4.5V, I _D = 18A	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)				•			
Input Capacitance	Ciss	_	864	—		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss		282	—	pF		
Reverse Transfer Capacitance	Crss	_	27	_			
Gate Resistance	R _G	-	1.3	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	8.4	-			
Total Gate Charge (V _{GS} = 10V)	Qg	_	17	-	nC	$V_{DS} = 30V, I_D = 10A$	
Gate-Source Charge	Q _{gs}	_	3.1	-	nc		
Gate-Drain Charge	Q _{gd}	_	4.3	-			
Turn-On Delay Time	t _{D(ON)}	_	3.4				
Turn-On Rise Time	t _R	_	5.2	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_G = 6\Omega, I_D = 10A$	
Turn-Off Delay Time	t _{D(OFF)}	_	13				
Turn-Off Fall Time	t _F		7	_	1		
Reverse Recovery Time	t _{RR}	—	22	_	ns		
Reverse Recovery Charge	Q _{RR}	—	11		nC	I _F = 10A, di/dt = 100A/µs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to product testing.



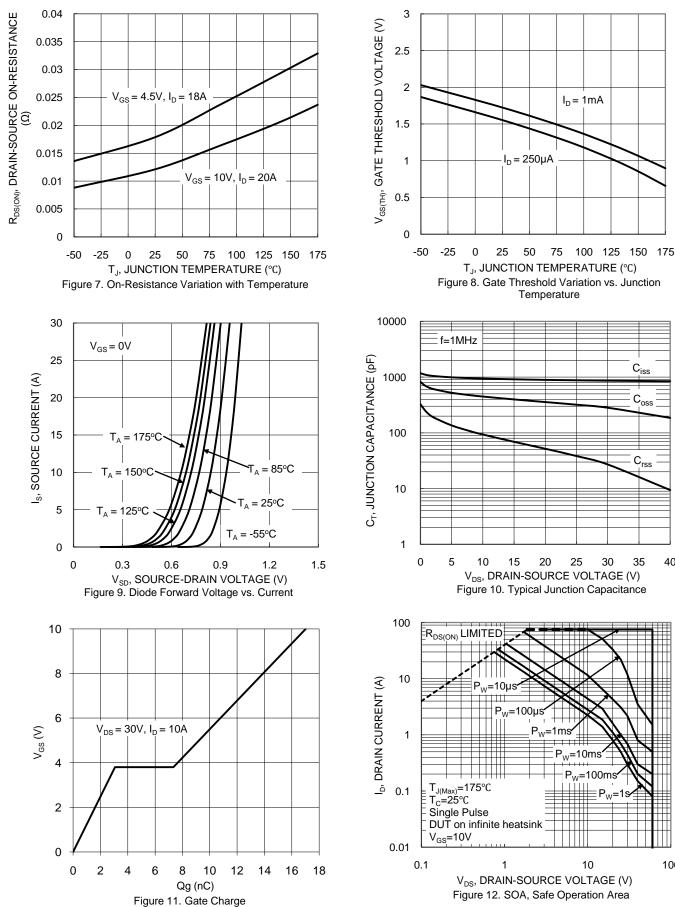
DMTH6016LPS



DMTH6016LPS Document number: DS38436 Rev. 1 - 2



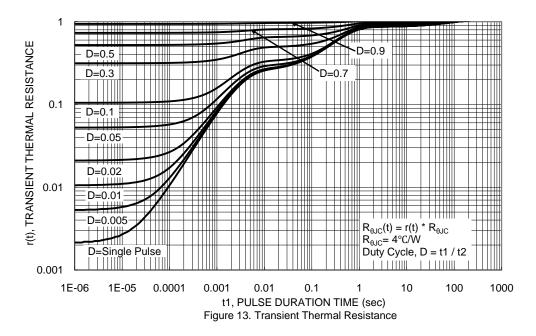
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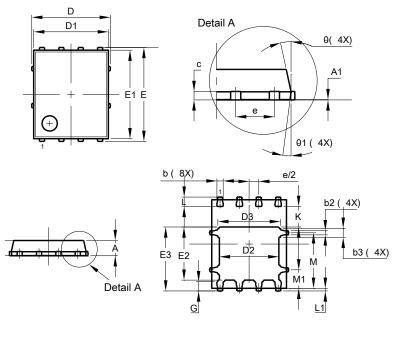




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

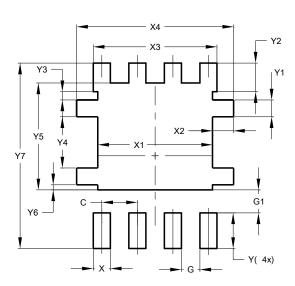
PowerDI5060-8



	PowerDI5060-8					
Dim	Min Max		Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05	-			
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
С	0.230	0.330	0.277			
D		5.15 BSC				
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90	4.30	4.10			
E	6.15 BSC					
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е	1.27 BSC					
G	0.51	0.71	0.61			
ĸ	0.51	-	-			
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
М	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
Θ	10º	12º	11º			
Θ1	6º	8º	7°			
All	Dimens	ions in m	ım			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8

Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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